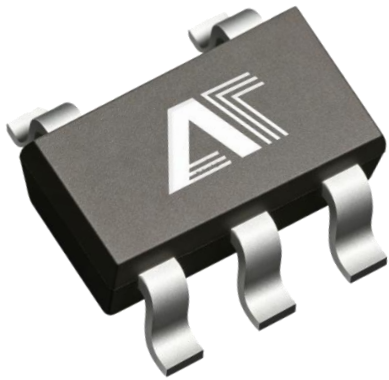




**Single-channel 2-input
positive AND gate**

SN74AHCT1G08

Product Data Sheet

**AOTE DCC
RELEASE**

◆ Summary :

The SN74AHCT1G08 is a single-channel 2-input positive AND gate, which can operate within a power supply voltage range of 2.0V to 5.5V.

The SN74AHCT1G08 device performs the Boolean functions $Y=A \cdot B$ or $Y=A+B$ in positive logic and can be used for Ioff (power-down) applications. When the device is powered off, the Ioff circuit will disable the output to prevent backflow current from damaging the device. The device is packaged in SOT23-5 and SC70-5. The working temperature range is from -40°C to $+125^{\circ}\text{C}$.

◆ Product features

- Small Package: SOT23-5、SC70-5
- Working voltage range: 2.0V~5.5V
- Low power consumption: 0.1 μA (typical value)
- Working temperature range: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$
- Input compatible TTL voltage
- High output drive: When powered by 5.0V, the output drive is $\pm 32\text{mA}$

◆ Applications

- Active Noise Cancellation
- barcode scanner
- blood pressure monitor
- CPAP machine
- Fingerprint recognition
- Network Attached Storage (NAS)

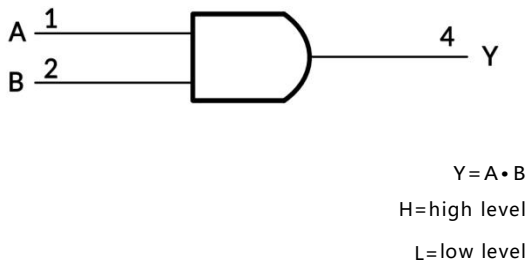
Packaging and Order Description

Product Name	Order Model	Temperature Range ($^{\circ}\text{C}$)	boxed type	screen printing	MSL(3)	Packing Specification
SN74AHCT1G08	SN74AHCT1G08DCKR	$-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$	SC70-5	BEG	MSL3	Tape and Reel, 3000
	SN74AHCT1G08DBVR	$-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$	SOT23-5	BO8S	MSL3	Tape and Reel, 3000

Attention:

- (1) This information is the latest data for the current version. If these data are updated, they will be promptly updated on our official website without further notice.
- (2) Silk screen printing may have additional codes for internal control traceability of products (including data codes and supplier codes) or marking the place of origin.
- (3) MSL, Humidity sensitivity level classified according to JEDEC industry standards.
- (4) equivalent SOT353

◆ **Logic diagram**

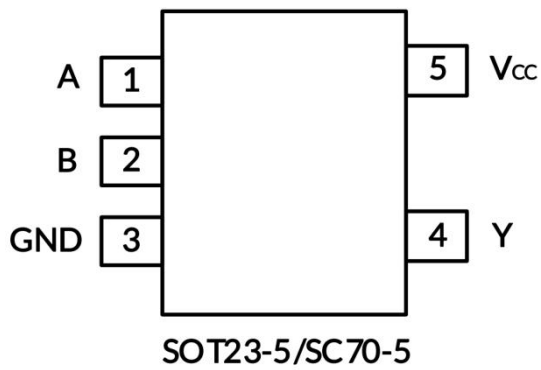


◆ **Menu**

Input		Output
A	B	Y
H	H	H
L	H	H
H	L	H
L	L	L

◆ **on-product information:**

• **Footage image**



Pin	Pin Name	I/O	Function Description
1	A	I	A input
2	B	I	B input
3	GND	P	grounding
4	Y	O	Y output
5	Vcc	P	power supply

◆ **Absolute maximum rating** Within the natural ventilation temperature range (unless otherwise specified)

	Parameter		Min	Max	Unit
VCC	Power supply voltage range		-0.5	6.5	V
VI	Input voltage range		-0.5	6.5	V
Vo	The voltage range applicable to any output under high impedance or power-off conditions		-0.5	6.5	V
Vo	The voltage range applicable to any output in either high or low level state		-0.5	VCC+0.5	V
IIK	Input clamp current	VI <0	-	-50	mA
IOK	Output clamp current	VO <0	-	-50	mA
IO	Continuous output current		-	± 50	mA
	Continuous current through VCC or GND		-	± 100	mA
• current parameters					
θ JA	Thermal resistance to the environment	SOT23-5	-	230	°C/W
		SC70-5	-	376	
• current parameters					
temperature parameter	Junction temperature, TJ		-65	150	°C
	Storage temperature range, Tstg		-65	150	

◆ ESD level

The following ESD information is only applicable to sensitive equipment operated within an ti-static protection zones

–	nominal value	Unit	 ESD sensitivity warning The scope of ESD damage can range from minor performance degradation to complete equipment failure. Precision integrated circuits may be more susceptible to damage as very small parameter changes can result in devices not meeting their published parameter specifications.
human model (HBM)	±2000	V	
Charged Device Model (CDM)	±1500		
Mechanical Model (MM)	±200		

Attention:

- (1) This only represents the limit values obtained by the product under testing conditions, and does not mean that the product can work normally under these conditions or other parameter conditions beyond the specifications. Exceeding the range specified by the absolute maximum rated value above will cause damage to the product, and it is impossible to predict the working state of the product outside of the above conditions. If the product operates under conditions other than those mentioned above for a long time, it may affect its performance.
- (2) If the input and output current ratings are followed, it may exceed the input and output negative voltage ratings.
- (3) The value of VCC is provided in the recommended working condition table.
- (4) The thermal impedance of the package is calculated according to JEDEC-51 standard:
- (5) The maximum power consumption is a function of $T_{J(MAX)}$, $R\theta_{JA}$, and T_A . The maximum power consumption at any ambient temperature is $P_o = (T_{J(MAX)} - T_A) / R\theta_{JA}$, which is suitable for packaging directly soldered to PCB.

◆ Electrical Characteristics

(Within the natural ventilation temperature range (typical test conditions are: TA=+25 ° C, full temperature=-40 ° C~125 ° C)

◆ Recommended working conditions

Parameter	symbol	Test conditions	Min	Max	Unit
power supply voltage	V _{CC}	work	2.0	5.5	V
High level input voltage	V _{IH}	V _{CC} =2.0V	1.0	-	V
		V _{CC} =3.3V	1.5	-	
		V _{CC} =4.5V - 5.5V	2.0	-	
Low level input voltage	V _{IL}	V _{CC} =2.0V	-	0.3	V
		V _{CC} =3.3V	-	0.55	
		V _{CC} =4.5V - 5.5V	-	0.8	
input voltage	V _I	-	0	5.5	V
output voltage	V _O	-	0	V _{CC}	V
Input conversion up or down rate	Δt/Δv	V _{CC} =2.0V- 5.5V	-	5	ns/V
Working temperature range under natural ventilation conditions	T _A	-	-40	125	°C

All unused input ports of the device must be kept at VCC or GND to ensure proper operation of the device

◆ DC characteristics

Parameter	Test conditions	Vcc	temperature	Min	Typ	Max	Unit
V _{OH}	I _{OH} = -100μA	2.0V-5.5V	Full temperature	V _{CC} -0.1	-	-	V
	I _{OH} = -8mA	2.0		1.6			
	I _{OH} = -24mA	3.3		2.5			
	-	4.5V		3.8			
	I _{OH} = -32mA	5V		4.2			
	-	5.5V		4.8			
V _{OL}	I _{OL} = 100μA	2.0V-5.5V	Full temperature	-	-	0.1	V
	I _{OH} = 8mA	2.0		-	-	0.45	
	I _{OH} = 24mA	3.3		-	-	0.55	
	-	4.5V		-	-	0.55	
	I _{OL} = 32mA	5V		-	-	0.5	
	-	5.5V		-	-	0.45	
I _I Input A or B	V _I = 5.5V or GND	0V - 5.5V	+25°C Full temperature	-	±0.1	±5	μA
I _{off}	V _I or V _O = 5.5V	0V	+25°C Full temperature	-	±0.1	±5	μA
I _{CC}	V _I = 5.5V or GND, I _O = 0	2.0V - 5.5V	25°C Full temperature	-	0.1	10	μA
I _{CC} T	One input at 3.4V, Other inputs at V _{CC} or GND	5.5V	Full temperature			500	μA
C _i Input capacitor	V _{CC} = 0V, f = 10MHz	0V	25°C	-	6	-	pF

(1) All unused input ports of the device must be kept at VCC or GND to ensure proper operation of the device.

(2) The limit value is 100% production testing conducted at 25°C. Ensure the limitation of the working temperature range by utilizing the correlation of statistical quality control (SQC) methods.

(3) Typical values represent the most likely parameter specifications determined during characterization. The actual typical values may vary over time and will also depend on the application and configuration.

◆ AC characteristics

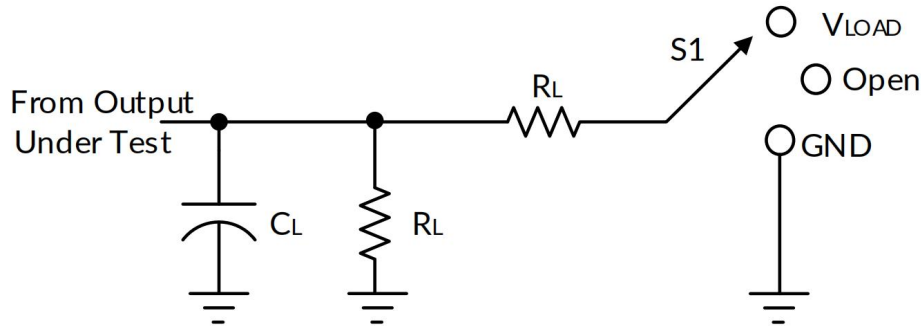
Parameter	symbol	Test conditions		Min	Typ	Max	Unit
propagation delay	tpd	V _{CC} = 2.0V ± 0.2V	C _L = 30pF, R _L = 500Ω	-	15.5	-	ns
		V _{CC} = 3.3V ± 0.3V	C _L = 50pF, R _L = 500Ω		13.5		
		V _{CC} = 5V ± 0.5V	C _L = 50pF, R _L = 500Ω		4.1		
Power consumption capacitor	Cpd	V _{CC} = 5V	f = 10MHz		22		pF

(1) All unused input ports of the device must be kept at VCC or GND to ensure proper operation of the device.

(2) This parameter is ensured by design and/or characteristics and has not been tested in production.

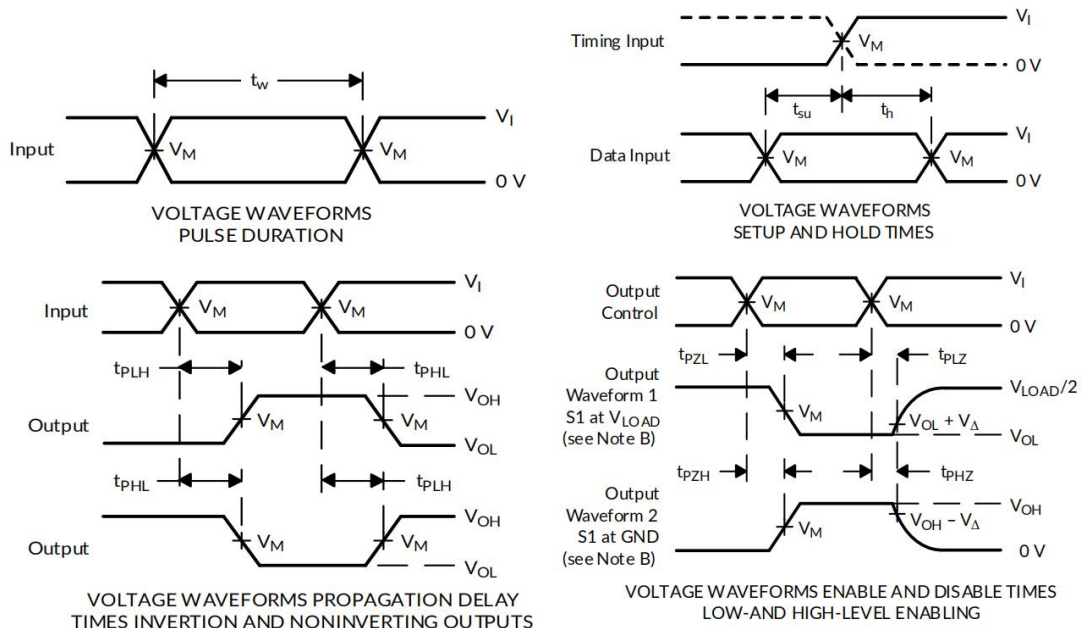
(3) Typical values represent the most likely parameter specifications determined during characterization. The actual typical values may vary over time and will also depend on the application and configuration.

◆ **Parameter measurement information**



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND

V_{CC}	INPUTS		V_M	V_{LOAD}	C_L	R_L	V_{Δ}
	V_I	t_r/t_f					
$2.0V \pm 0.2V$	V_{CC}	$\leq 2ns$	$V_{CC}/2$	$2 \times V_{CC}$	30pF	500Ω	0.15V
$3.3V \pm 0.3V$	3V	$\leq 2.5ns$	1.5V	6V	50pF	500Ω	0.3V
$5V \pm 0.5V$	V_{CC}	$\leq 2.5ns$	$V_{CC}/2$	$2 \times V_{CC}$	50pF	500Ω	0.3V



Note: A.CL includes probe and fixture capacitors.

B. Waveform 1 is used for outputs with internal conditions, where the output is low unless disabled by the output controller. Waveform 2 is used for outputs with internal conditions, where the output is high unless disabled by the output controller.

C. All input pulses are provided by a generator with the following characteristics: $PRR \leq 10MHz$, $Z_o = 50\Omega$

D. Output one measurement at a time, with a transition for each measurement.

E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .

F. t_{PZL} and t_{PZH} are the same as t_{en} .

G. t_{PLH} and t_{PHL} are the same as t_{pd} .

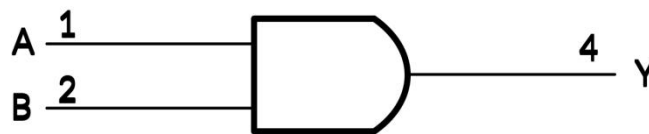
H. Not all parameters and waveforms are applicable to all devices.

◆ Detailed description

Overview:

The SN74AHCT1G08 device is a single channel 2-input positive AND gate. The device executes Boolean functions ($Y=A \cdot B$ or $Y=\overline{A+B}$) in positive logic, and its low Lcc current makes it suitable for power sensitive or battery powered applications. The robust input allows the device to perform a rising transition with a propagation delay of 4.1 ns.

Functional Block Diagram



Feature Description

- The VCC of this device is optimized to 5V;
- Input accepts a VIH level of 2V;
- Reduce output ringing to a minimum through slow edge rate
- Input compatible TTL voltage;

Application and Design

Application Information:

The SN74AHCT1G08 device is a single channel AND gate commonly used for general functions such as power timing control or LED status indication. Due to the device being configured to only output high level when all inputs are high, otherwise output low level, the LED connected to the device output will only become high level when all connected systems send high or ready signals.

Design requirements:

This device adopts CMOS technology and has balanced output drive. Attention should be paid to avoiding bus contention as it may drive currents exceeding the maximum limit. High drive can also generate fast edges in light loads, so wiring and load conditions should be considered to prevent ringing.

Power recommendations

The power pins should be equipped with good bypass capacitors to prevent power interference. For devices powered by a single power source, it is recommended to use a 0.1F capacitor; For devices with multiple VCC pins, it is recommended to use capacitors with 0.01 μ F or 0.022 μ F for each power pin. Multiple bypass capacitors can be connected in parallel to suppress noise of different frequencies. Usually, capacitors with 0.1 μ F and 1 μ F are used in parallel. The bypass capacitor should be installed as close as possible to the power supply pin.

◆ PCB layout design

Precautions for PCB layout design:

When using multi bit logic devices, the input pins should not be suspended. In practical applications, some functions of digital logic devices are often idle, such as using only two inputs from the three input gate or enabling only three gates from the four buffer gate. These unused input pins should not be left hanging, as undefined external connection point voltage will cause abnormal device operation. The following specifies the rules that must be followed in all situations. All idle input pins must be connected to a high or low bias to eliminate the risk of floating. The specific logic level that needs to be applied to the idle pin depends on the device's functional characteristics. The conventional approach is to connect it to GND or VCC, depending on the actual convenience.

PCB layout diagram:

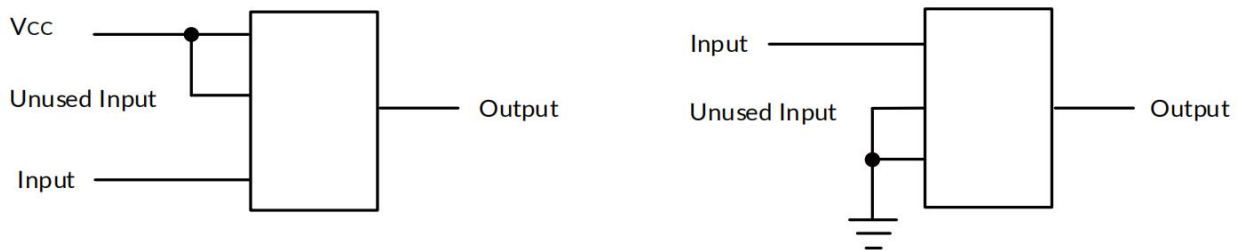
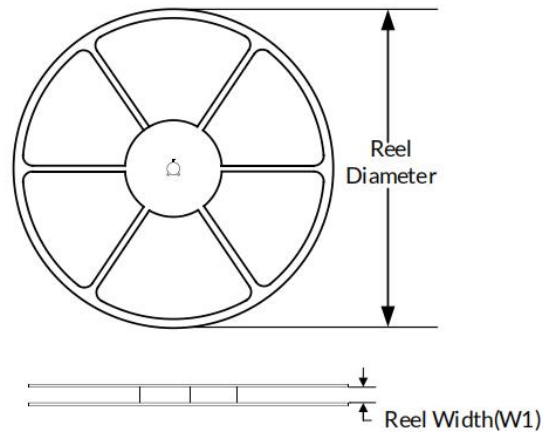


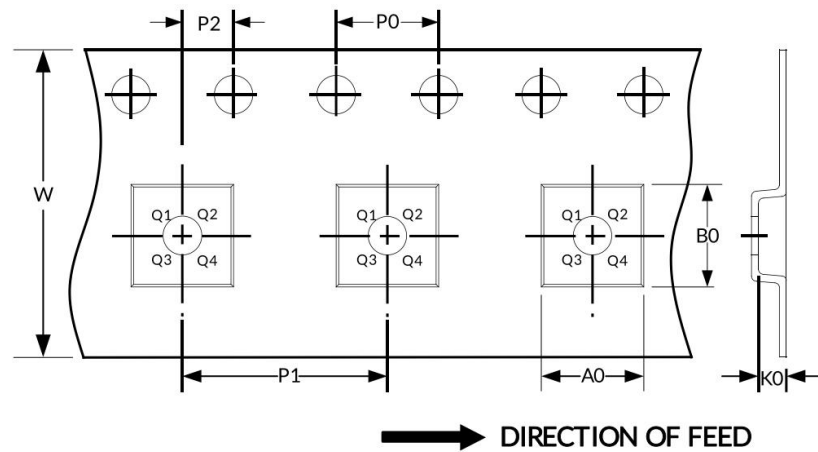
Figure 2. PCB layout diagram

◆ Packaging specifications size

REEL DIMENSIONS



TAPE DIMENSION



Attention: The pictures are for reference only. Please use the physical object as the standard

◆ Key parameter table

Package Type	Reel Diameter	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SC70-5	7"	9.5	2.25	2.55	1.20	4.0	4.0	2.0	8.0	Q3
SOT23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3

Attention:

All dimensions are nominal sizes.

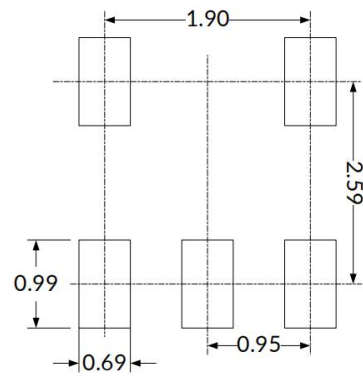
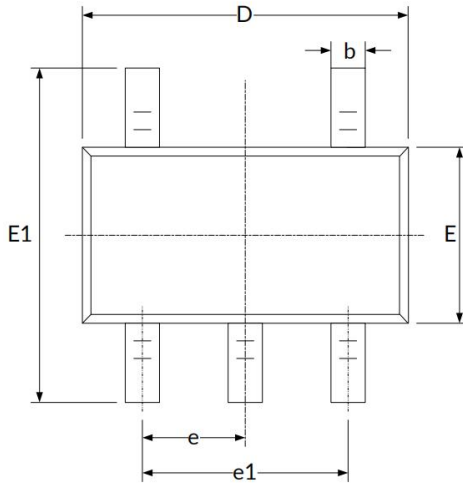
Excluding plastic wrap or metal protrusions with a maximum of 0.15 millimeters on each side.

◆ Packaging specifications and dimensions

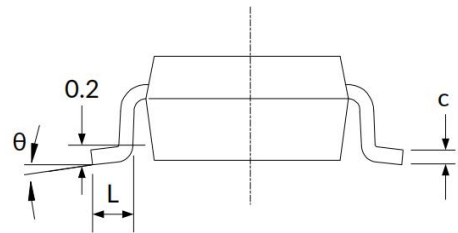
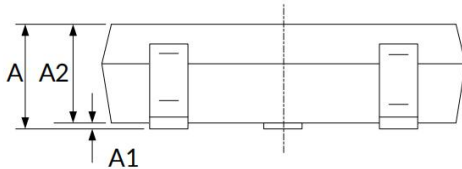
Attention:

- 1、Excluding plastic wrap or metal protrusions with a maximum of 0.15mm on each side.
- 2、BSC (Basic Center Spacing), where the "basic" spacing is the nominal spacing.
- 3、This image is subject to change without prior notice

SOT23-5



RECOMMENDED LAND PATTERN (Unit: mm)



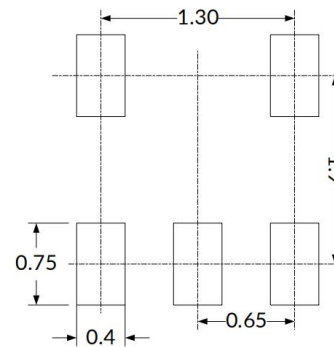
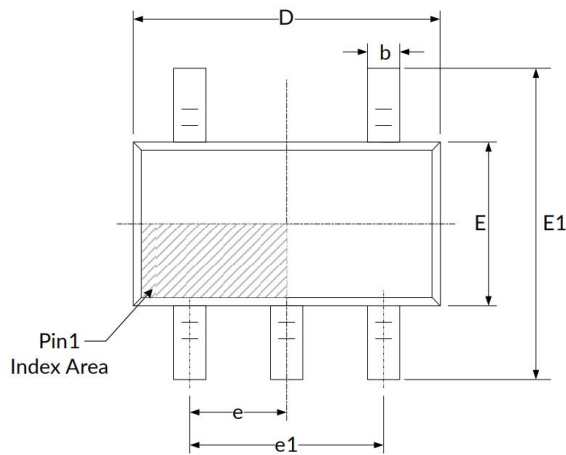
symbol	Dimensions (in millimeters)		Dimensions (in inches)	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
C	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 (BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

◆ Packaging specifications and dimensions

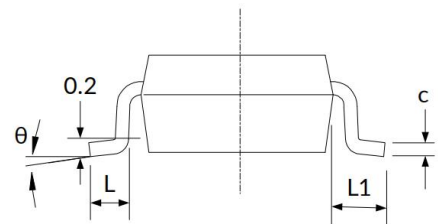
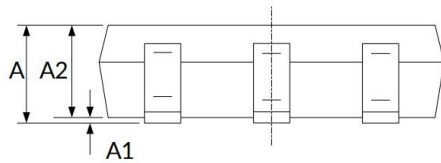
Attention:

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- 2、BSC (Basic Center Spacing), where the "basic" spacing is the nominal spacing.
- 3、This image is subject to change without prior notice

SC70-5



RECOMMENDED LAND PATTERN (Unit: mm)



symbol	Dimensions (in millimeters)		Dimensions (in inches)	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 (BSC)		0.026(BSC)	
e1	1.300 (BSC)		0.051(BSC)	
L	0.260	0.460	0.010	0.018
L1	0.525		0.021	
θ	0°	8°	0°	8°

◆ Attention

- AOTE implements dynamic technical updates. Specifications are subject to change. Refer to the official website for the latest version.
- Users must strictly adhere to specified conditions. Failures caused by misuse (overload, high temperature, incompatible circuits) are excluded from warranty.
- Contact technical support for customized validation in critical applications (medical devices, industrial control).
- This document is valid until December 31, 2026 Updates will be notified on the official website.
- For further clarification on technical specifications or application solutions, please contact us through official channels: